

March 2015

FGH60N60SFD 600 V, 60 A Field Stop IGBT

Features

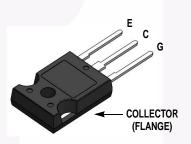
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 2.3 V @ I_C = 60 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

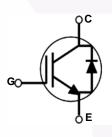
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		±20	V	
	Transient Gate-to-Emitter Voltage	±30			
I _C	Collector Current	@ T _C = 25°C	120	A	
	Collector Current	@ T _C = 100 ^o C	60	А	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	180	A	
P _D	Maximum Power Dissipation	@ T _C = 25 ^o C	378	W	
	Maximum Power Dissipation	@ T _C = 100°C	151	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1: Repetitive test, Pulse width limited by max. juntion temperature

Thermal Characteristics

Symbol Parameter		Тур.	Max.	Unit	
$R_{\theta JC}(IGBT)$	JC(IGBT) Thermal Resistance, Junction to Case		0.33	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

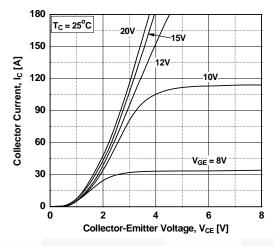
Part NumberTop MarkPackageFGH60N60SFDTUFGH60N60SFDTO-247		Packing Method	Reel Siz	e	Tape Wid	lth Qu	Quantity		
		Tube	N/A		N/A		30		
Electric	al Ch	aracteristics	s of the IC	GBT $T_c = 25^{\circ}C$ unless other	wise noted			I.	
Symbol			Test Condition		Min.	Тур.	Max.	Unit	
Off Charac	teristics	;							
BV _{CES}	Collector to Emitter Breakdown Voltage		V _{GE} = 0 V, I _C = 250 μA		600	-	-	V	
ΔBV _{CES} / ΔT _J	Temperature Coefficient of Breakdown Voltage		V _{GE} = 0 V, I _C = 250 μA		-	0.4	-	V/ºC	
ICES	Collect	Collector Cut-Off Current		V _{CE} = V _{CES} , V _{GE} = 0 V		-	-	250	μA
I _{GES}	G-E Leakage Current			$V_{GE} = V_{GES}, V_{CE} = 0 V$		-	-	±400	nA
On Charac	teristics								
V _{GE(th)}	G-E Threshold Voltage			$I_C = 250 \ \mu\text{A}, \ V_{CE} = V_{GE}$		4.0	5.0	6.5	V
				I _C = 60 A, V _{GE} = 15 V		-	2.3	2.9	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage		$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$		-	2.5	-	V	
Dynamic C	haracte	ristics							
C _{ies}	Input Capacitance					-	2820	-	pF
C _{oes}	Output	Capacitance		$V_{CE} = 30 V, V_{GE} = 0 V,$		-	350	-	pF
C _{res}	Revers	e Transfer Capacitance		f = 1 MHz		-	140	-	pF
Switching	Charact	eristics			ľ				
t _{d(on)}	Turn-O	n Delay Time				-	22	-	ns
t _r	Rise Ti	me				-	42	-	ns
t _{d(off)}	Turn-O	ff Delay Time		V_{CC} = 400 V, I _C = 60 A, R _G = 5 Ω, V _{GE} = 15 V,		-	134	-	ns
t _f	Fall Tin	ne			-	-	31	62	ns
Eon	Turn-O	n Switching Loss		Inductive Load, T _C = 25 ^o	C	-	1.79	-	mJ
E _{off}	Turn-O	ff Switching Loss				-	0.67	-	mJ
E _{ts}	Total S	witching Loss				- /	2.46	-	mJ
t _{d(on)}	Turn-O	n Delay Time				22	22	-	ns
t _r	Rise Ti	me				-	44	-	ns
t _{d(off)}	Turn-O	ff Delay Time		$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 60 \text{ A},$		-	144	-	ns
t _f	Fall Tin	ne	$R_{G} = 5 \Omega, V_{GE} = 15 V,$.00	-	43	-	ns
E _{on}	Turn-O	n Switching Loss		Inductive Load, T _C = 125		-	1.88	-	mJ
E _{off}	Turn-O	ff Switching Loss				-	1.0	-	mJ
E _{ts}	Total S	witching Loss					2.88	-	mJ
Q _g	Total G	ate Charge				-	198	-	nC
Q _{ge}	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$		-	22	-	nC
Q _{gc}	Gate to	Collector Charge		V _{GE} = 15 V		-	106	-	nC

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 30 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.0	2.6	V
		1F - 00 / 1	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.8	-	
t _{rr}	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	47	-	ns
		I _F = 30 A, di _F /dt = 200 A/μs	$T_{C} = 125^{\circ}C$	-	179	-	
Q _{rr}	Diode Reverse Recovery Charge	$r_{\rm F} = 30$ A, $u_{\rm F}/u_{\rm c} = 200$ A/ μ 3	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	83	-	nC
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	567	-	

FGH60N60SFD — 600 V, 60 A Field Stop IGBT

Typical Performance Characteristics

Figure 1. Typical Output Characteristics





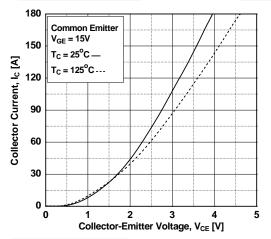
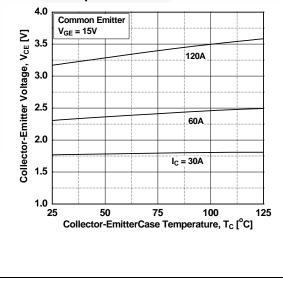
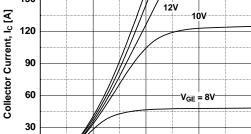


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level





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Collector-Emitter Voltage, V_{CE} [V]

Figure 2. Typical Output Characteristics

20V

15V

6

8

180

150

0

0

T_C = 125°C

Figure 4. Transfer Characteristics

2

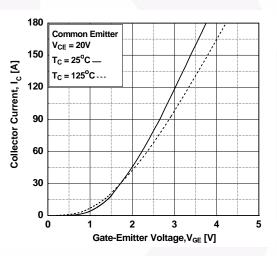
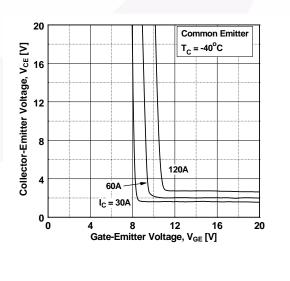


Figure 6. Saturation Voltage vs. V_{GE}



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Typical Performance Characteristics

Figure 7. Saturation Voltage vs. V_{GE}

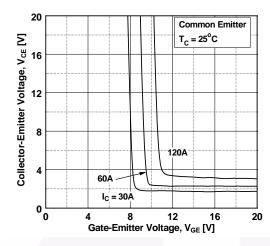
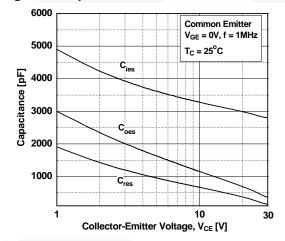
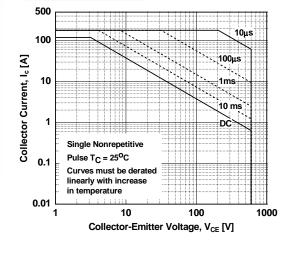
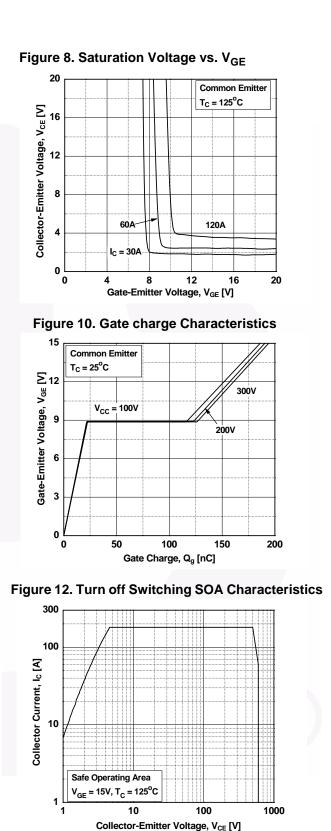


Figure 9. Capacitance Characteristics

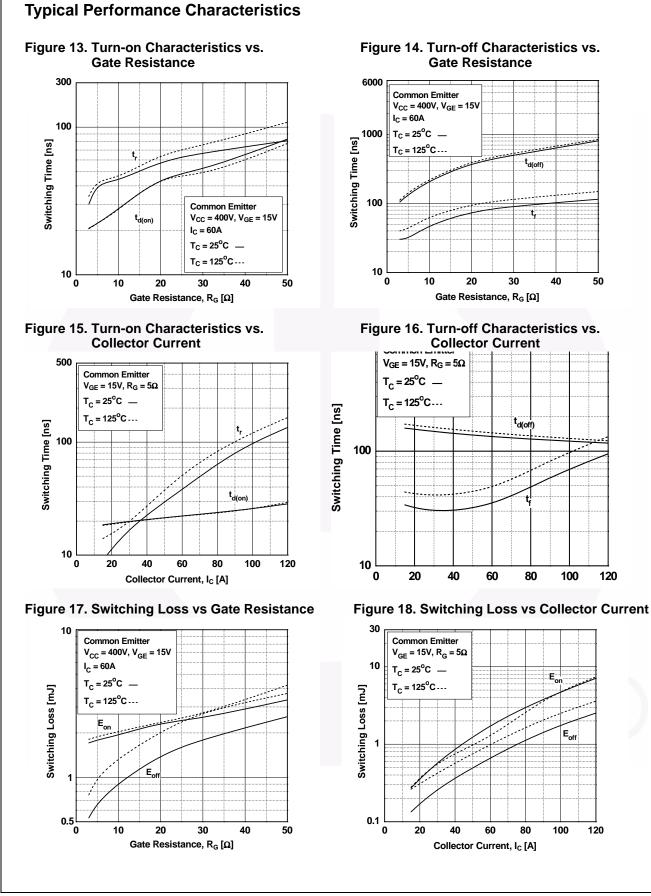




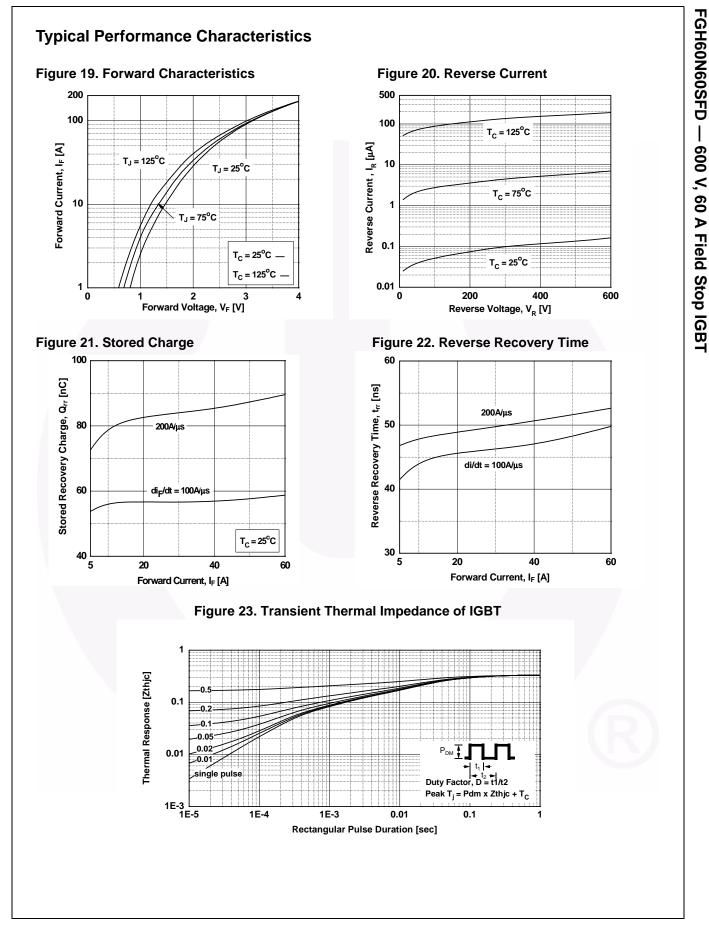




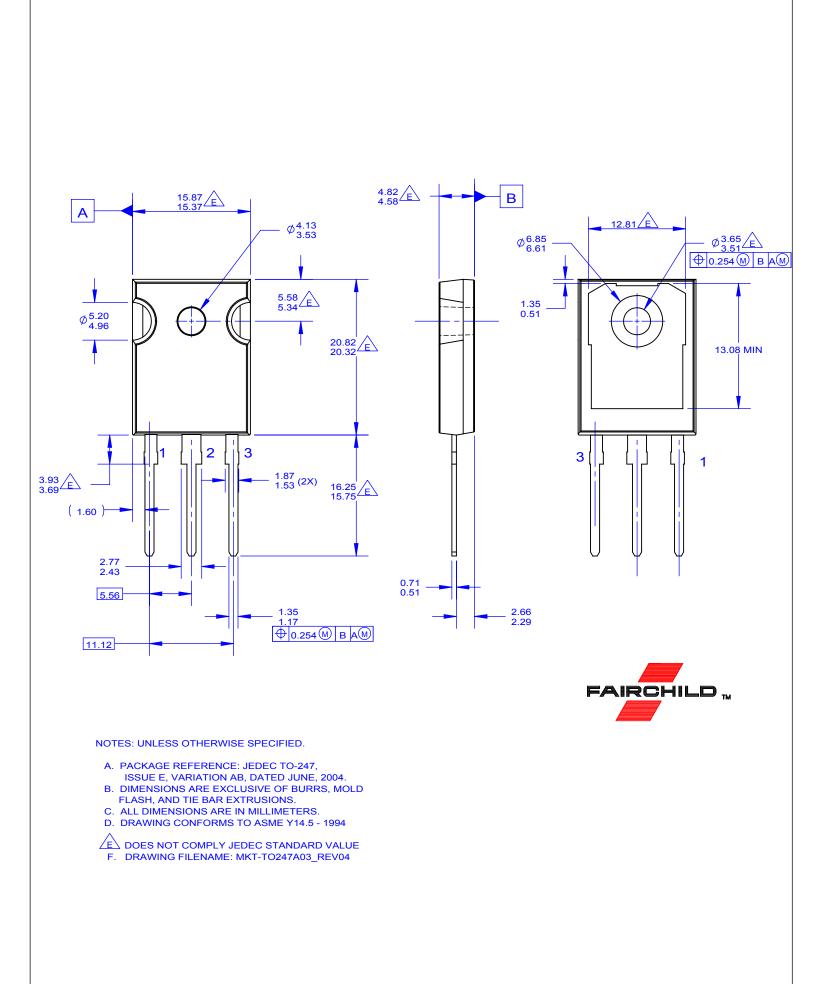
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